



Qualcomm Technologies, Inc.

# **QCC743-1 Module**

## **Reference Schematic**

80-78830-41 Rev. AD

June 11, 2025

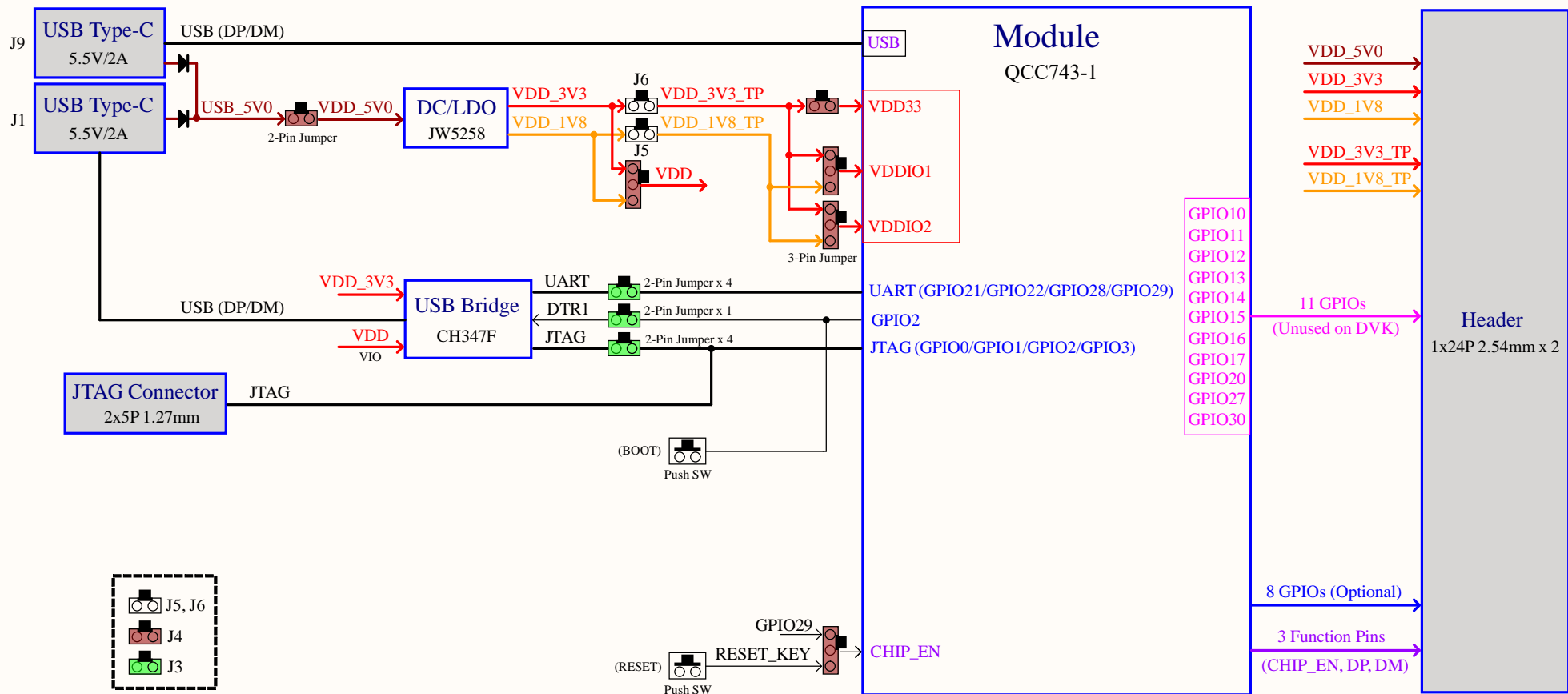
# **1 Reference schematic**

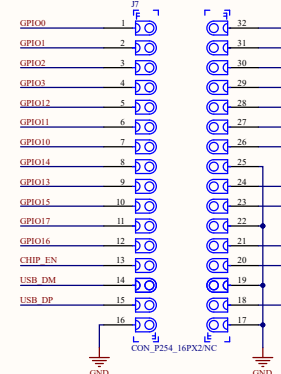
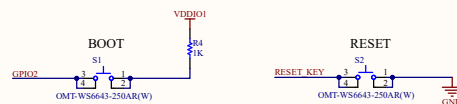
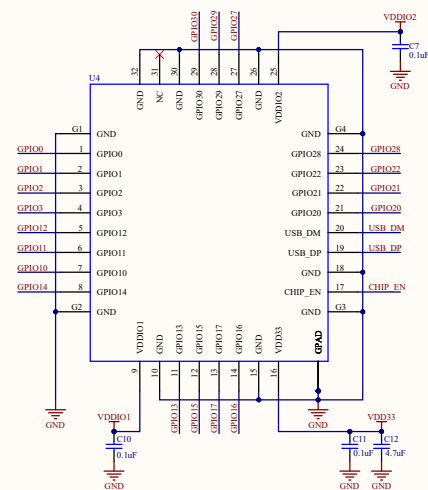
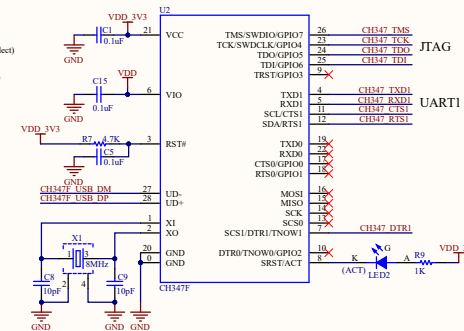
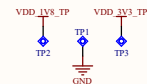
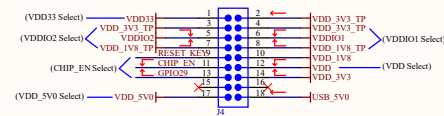
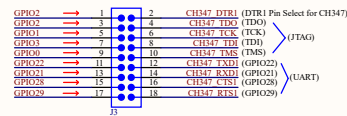
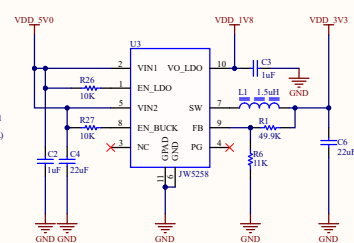
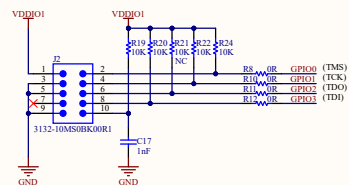
## **1.1 Introduction**

This document includes the schematic for the QCC743-1 Module.

## **1.2 Schematic**

This schematic is subject to change without notice, and is not optimized for production products due to its conservative design approach and internal test requirements.





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